# QME48T35120 Quarter-Brick DC-DC Converter

The new high performance 35A **QME48T35120** DC-DC converter provides a high efficiency single output, in a 1/4 brick package. Specifically designed for operation in systems that have limited airflow and increased ambient temperatures, the QME48T35120 converter utilizes the same pin-out and Input/Output functionality of the industry-standard quarter-bricks. In addition, a baseplate feature is available (-xxxBx suffix) that provides an effective thermal interface for coldplate and heat sinking options.

The QME48T35120 converter thermal performance is accomplished through the use of patent-pending circuits, packaging, and processing techniques to achieve ultra-high efficiency, excellent thermal management, and a low-body profile.

Low-body profile and the preclusion of heat sinks minimize impedance to system airflow, thus enhancing cooling for both upstream and downstream devices. The use of 100% automation for assembly, coupled with advanced electronic circuits and thermal design, results in a product with extremely high reliability.

Operating from a wide-range 36-75V input, the QME48T35120 converter provides a fully regulated 12.0V output voltage. Employing a standard power pin-out, the QME48T35120 converter is an ideal drop-in replacement for existing high current quarter-brick designs. Inclusion of this converter in a new design can result in significant board space and cost savings. The designer can expect reliability improvement over other available converters because of the QME48T35120 optimized thermal efficiency.

#### **Key Features & Benefits**

- RoHS lead-free solder and lead-solder-exempted products are available
- Delivers up to 35 A (420 Watts)
- Industry-standard quarter-brick pinout
- On-board input differential LC-filter
- Startup into pre-biased load
- No minimum load required
- Meets Basic Insulation requirements of EN60950-1
- Withstands 100 V input transient for 100 ms
- Fixed frequency operation
- Fully protected (OTP, OCP, OVP, UVLO) with automatic recovery
- Positive or negative logic ON/OFF option
- Low height of 0.430" (10.4mm)
- Weight: 1.75 oz (49.6g), 2.15 oz (61.0g) w/baseplate
- High reliability: MTBF approx. 18.8 million hours, calculated per Telcordia TR-332, Method I Case 1
- Approved to the latest edition and amendment of ITE Safety standards, UL/CSA 60950-1 and IEC60950-1
- Designed to meet Class B conducted emissions per FCC and EN55022 when used with external filter
- All materials meet UL94, V-0 flammability rating







## **1. ELECTRICAL SPECIFICATIONS**

Conditions:  $T_A = 25^{\circ}C$ , Airflow = 300 LFM (1.5 m/s), Vin = 48 VDC, unless otherwise specified.

Absolute Maximum Ratings         0         80         VDC           Input Voltage         00 ms         0         80         VDC           Operating Omponent Temperature (Ta)         -40         85         *C           Operating Omponent Temperature (Ta)         -40         85         *C           Operating Omponent Temperature (Ta)         -40         105         *C           Operating Omponent Temperature (Ta)         Turn-on Threshold         31.5         34         35.5         VDC           Input Under Voltage Lockout (Non-latching)         Turn-on Threshold         30         33         34.5         VDC           Input Stand-by Current         Converter disabled         10         mADC           Input Stand-by Current         Converter disabled         10         mADC           Input Beltected-Ripple Current, is         25         Mizb bandwidth, Io = 35 Amperes         100         10         mADC <th>PARAMETER</th> <th>CONDITIONS / DESCRIPTION</th> <th></th> <th>MIN</th> <th>ТҮР</th> <th>MAX</th> <th>UNITS</th>	PARAMETER	CONDITIONS / DESCRIPTION		MIN	ТҮР	MAX	UNITS
Input Pransient Woltage         100 ms         100         VDC           Operating Ambient Temperature (Ta)         -40         85         °C           Operating Component Temperature (Ta)         -40         125         °C           Operating Basepiate Temperature (Ta)         -40         105         °C           Storage Temperature         -56         125         °C           Operating Input Voltage Range         36         48         75         VDC           Input Undervoltage Lockout (Non-latching)         Tum-on Threshold         31.5         34         35.5         VDC           Input Under Voltage Transient Rate         7         Wrins         70         Wrins           Input Stand-by Current         35 ADC, 12 VDC Out @ 36 VDC In         11.3         ADC           Input Voltage Transient Rate         7         Wrins         mAbC           Input Stand-by Current         Converter alsabled         10         mAbC           Input Voltage Ripple Current, Is         (Figure 39)         150         mAscare           Input Voltage Ripple Rejecton         120 Hz         45         48           Output Voltage Ripple Rejecton         120 Hz         45         48           Output Voltage Ripple Rejecton         120 Hz<	Absolute Maximum Ratings						
Operating Ambient Temperature (Ta)         -40         85         "C"           Operating Component Temperature (Ta)         -40         125         "C"           Operating Baseplate Temperature (Ta)         -40         105         "C"           Storage Temperature (Ta)         -40         105         "C"           Operating Ingus Parature (Ta)         -40         31.5         "A"         "S"           Operating Ingus Parature (Ta)         Tum-on Threshold         31.5         34         35.5         "VDC           Operating David Voltage Range         0.5         2         VDC         "D"         "P"         "Machine Ingul Parature (Ta)         ADC           Input Voltage Transient Rate         -         0.5         2         VDC           Maximum Ingut Current         35 ADC, 12 VDC Out @ 36 VDC In         12.3         ADC           Input Stand-by Current         Converter alabled         10         mAbce           Input Reflected-Ripple Current, is         EST ME2 bandwidth, lo = 35 Amperes <t< td=""><td>Input Voltage</td><td>Continuous</td><td></td><td>0</td><td></td><td>80</td><td>VDC</td></t<>	Input Voltage	Continuous		0		80	VDC
Operating Component Temperature (Ta)         4-40         125         "C           Operating Baseplate Temperature (Ta)         -40         105         "C           Storage Temperature         -55         125         "C           Input Characteristics         -55         125         "C           Operating Input Voltage Range         36         48         75         VDC           Input Under Voltage Lockout (Non-latching)         Turn-on Threshold         31.5         34         35.5         VDC           Input Voltage Transient Rate         0.5         2         VDC         VDC         VDC         VDC         VDC         Input Stand-by Current         35 ADC, 12 VDC Out @ 36 VDC In         12.3         ADC           Input Voltage Transient Rate         0.5         2         VDC         Input @ 36 VDC In         12.3         ADC           Input Current         35 ADC, 12 VDC Out @ 36 VDC In         12.3         ADC         Input Current         Input Current         0.1         APS           Input Reflected-Ripple Current, is         Converter enabled         95         mADC         Input Reflected-Ripple Current, is         1250         mAPA:ex           Input Reflected-Ripple Current, is         (Figure 39)         100         mAPA:ex         Inp	Input Transient Voltage	100 ms				100	VDC
Operating Baseplate Temperature (Ta)       -40       105       °C         Storage Temperature       -55       125       °C <i>input Characteristics</i>	Operating Ambient Temperature (T <sub>A</sub> )			-40		85	°C
The second s	Operating Component Temperature (Tc)			-40		125	°C
$\begin{tabule}{linear definitions of the set of the s$	Operating Baseplate Temperature (T <sub>B</sub> )			-40		105	°C
Operating input Voltage Range $36$ $48$ $75$ VDC           Input Under Voltage Lockout (Non-latching)         Turn-on Threshold $31.5$ $34$ $35.5$ VDC           Lockout Hysteresis Voltage $0.5$ $2$ VDC           Input Voltage Transient Rate $0.5$ $2$ VDC           Input Voltage Transient Rate $5$ $2$ VDC           Input Stand-by Current $35$ ADC, 12 VDC Out @ $36$ VDC In $12.3$ ADC           Input Stand-by Current         Converter disabled $10$ mADC           Input Current @ No Load         Converter enabled $95$ mADC           Input Reflected-Ripple Current, ic $25$ MHz bandwidth, lo = $35$ Amperes $120$ $mAec.rec           Input Voltage Ripple Rejection         120 Hz         45 dB 00 mAec.rec           Output Voltage Ripple Rejection         120 Hz         5 mV mV mV           Output Voltage Range1         Vin = 39 to 75VDC [lour = 35 Amperes         100 12.4 VDC           Output Voltage Range1         Vin = 39 to 75VDC [lour = 35 Amperes         100 $	Storage Temperature			-55		125	°C
$\begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Input Characteristics						
Input Under Voltage Lockout (Non-latching)         Turn-off Threshold         30         33         34.5         VOC           Lockout Hysteresis Voltage         0.5         2         VOC           Input Voltage Transient Rate         7         Virns           Maximum Input Current         35 ADC, 12 VDC Out @ 36 VDC In         12.3         ADC           Input Stand-by Current         Converter disabled         10         mADC           Input Current @ No Load         Converter enabled         95         mADC           Input Reflected-Ripple Current, is         25 MHz bandwidth, lo = 35 Amperes         1250         mAnc.rec           Input Reflected-Ripple Current, is         25 MHz bandwidth, lo = 35 Amperes         1250         mAnc.rec           Input Voltage Ripple Rejection         12 U Hz         45         0         0           Output Voltage Set Point (no load) <sup>1</sup> 11.76         12.00         12.4         VDC           Output Voltage Range <sup>1</sup> Over line (39 to 75VDC [lour = 35Amps]         160         ±120         mV           Output Voltage Range <sup>1</sup> Vore ine (39 to 75VDC, load and temp. <sup>2</sup> 11.64         ±12.06         VDC           Output Voltage Range <sup>1</sup> Over line (39 to 75VDC), load and temp. <sup>2</sup> 11.64         ±12.36         VDC<	Operating Input Voltage Range			36	48	75	VDC
Turn-off Threshold         30         33         34.5         VDC           Lackout Hysteresis Voltage         0.5         2         VDC           Input Voltage Transient Rate         7         V/ms           Maximum Input Current         35 ADC, 12 VDC Out @ 36 VDC In         12.3         ADC           Input Stand-by Current         Converter disabled         10         mADC           Input Gurrent @ No Load         Converter enabled         95         mADC           Minimum Input Capacitance (external)         ESR < 0.7 Q	Input Linder Voltage Leakout (Nen Intehing)	Turn-on Threshold		31.5	34	35.5	VDC
Input Voltage Transient Rate7V/msMaximum Input Current35 ADC, 12 VDC Out @ 36 VDC In12.3ADCInput Stand-by CurrentConverter disabled10mADCInput Current @ No LoadConverter enabled95mADCMaximum Input Capacitance (external)ESR < 0.7 $\Omega$ 150 $\mu$ FInrush Transient0.1A <sup>2</sup> S1250mApc.extInput Reflected-Ripple Current, ic Input Reflected-Ripple Current, is (Figure 39)120mApc.extInput Voltage Ripple Rejection120 Hz45dBOutput Voltage Ste Point (no load)'11.7612.0012.24VDCOutput Voltage Range¹Vin = 39 to 75VDC [lour = 35Amps]±60±120mVOver LineVin = 39 to 75VDC [lour = 35Amps]±60±12.0mVOutput Voltage Range¹Over line (36 to 75VDC), load and temp.²11.06±2.36VDCOutput Voltage Range¹Over line (36 to 75VDC), load and temp.²11.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidth, '-xxxBx 'ESR0mV/msmQSuffix '-xxxBx 'CExr020,000 $\mu$ FmQSuffix '-xxxBx 'ESR1.00mQmQmVSuffix '-xxxBx 'CExr020,000 $\mu$ FmQSuffix '-xxxBx 'ESR1.00mQmQmQOutput Voltage Range¹0010012.36VDCmQOutput Ripple and Noise - 20 MHz bandwidth, '-xxxBx 'ESR1.00<	input onder voltage Lockout (Non-latching)	Turn-off Threshold		30	33	34.5	VDC
Note12.3ADCMaximum Input Current35 ADC, 12 VDC Out @ 36 VDC In12.3ADCInput Stand-by CurrentConverter disabled10mADCInput Current @ No LoadConverter enabled95mADCMinimum Input Capacitance (external)ESR < 0.7 $\Omega$ 150 $\mu$ FInrush Transient0.1A*SInput Reflected-Ripple Current, is (Figure 39)100mAex.extInput Voltage Ripple Rejection120 Hz45dBOutput Voltage Set Point (no load)^112.0 Hz11.7612.0012.24VDCOutput Voltage Range1Over Line Over Line11.7612.0012.24VDCOutput Voltage Range1Over line (39 to 75VDC [lour = 35Amps]±60±120mVOver Line Output Voltage Range1Over line (39 to 75VDC), load and temp.211.6412.36VDCOutput Ripple and Noise – 20 MHz bandwidth External Load Capacitance (Resistive load)Suffix '-xxxBx 'Cerr0mVExternal Load Capacitance (Resistive load)suffix '-xxxBx 'Cerr0mVmQSuffix '-xxxBx 'Cerr020,000 $\mu$ FmQSuffix '-xxxBx 'Cerr020,000 $\mu$ FmQSuffix '-xxxBx 'Cerr020,000 $\mu$ FmQSuffix '-xxxBx 'Cerr07000 $\mu$ FmQSuffix '-xxxBx 'Cerr07000 $\mu$ FmQSuffix '-xxxBx S377 'ESR1.7mQMQ <td>Lockout Hysteresis Voltage</td> <td></td> <td></td> <td>0.5</td> <td></td> <td>2</td> <td>VDC</td>	Lockout Hysteresis Voltage			0.5		2	VDC
Input Stand-by CurrentConverter disabled10mADCInput Current @ No LoadConverter enabled95mADCMinimum Input Capacitance (external)ESR < 0.7 $\Omega$ 150µFInrush Transient0.1A*SInput Reflected-Ripple Current, is (Figure 39)25 MHz bandwidth, lo = 35 Amperes (Figure 39)100mAexceetInput Voltage Ripple Rejection120 Hz45dBOutput Obtage Set Point (no load) <sup>1</sup> 11.7612.0012.24VDCOutput Voltage Set Point (no load) <sup>1</sup> 11.7612.00±60±120mVOver LineVin = 39 to 75VDC [lour = 35Amps]±60±120mVOver LineVoer line (39 to 75VDC), load and temp.²11.6412.36VDCOutput Voltage Range <sup>1</sup> Over line (39 to 75VDC), load and temp.²11.00150mVex.exOutput Ripple and Noise – 20 MHz bandwidthlour = 35Amps100150mVex.exExternal Load Capacitance (Resistive load)suffix '-xxxBx 'Cexr020,000µFsuffix '-xxxBx 'Cexr020,000µFmQsuffix '-xxxBx 'Cexr020,000µFsuffix '-xxxBx 'Cexr07,000µFsuffix '-xxxBx 'Cexr07,000µFsuffix '-xxxBx S377 'ESR1,0143%JoreatCurrent Limit InceptionNon-latching110143%Joreat	Input Voltage Transient Rate					7	V/ms
Number Input Current @ No LoadConverter enabled95mADCMinimum Input Capacitance (external)ESR < 0.7 $\Omega$ 150 $\mu$ FInrush Transient0.1A <sup>2</sup> SInput Reflected-Ripple Current, ic25 MHz bandwidth, Io = 35 Amperes (Figure 39)100mApec.pecInput Voltage Ripple Rejection120 Hz45dBOutput Voltage Ripple Rejection120 Hz11.7612.0012.24VDCOutput Voltage Set Point (no load) <sup>1</sup> Vin = 39 to 75VDC [lour = 35Amps]±60±120mVOver LineVin = 39 to 75VDC [lour = 35Amps]±60±120mVOutput Voltage Range <sup>1</sup> Over line (39 to 75VDC), load and temp. <sup>2</sup> 11.6412.36VDCOutput Voltage Range <sup>1</sup> Over line (36 to 75VDC), load and temp. <sup>2</sup> 11.00150mVre.pecOutput Ripple and Noise - 20 MHz bandwidthcext = 10 µF tantalum + 1 µF ceramic60mVrmsExternal Load Capacitance (Resistive load)suffix '-xxxBx 'Cext = 020,000µFSuffix '-xxxBx 'Cext = 020,000µFmQSuffix '-xxxBx 'Cext = 2707000µFSuffix '-xxxBx 'Cext = 2707000µFSuffix '-xxxBx S377 'ESR1.7mQOutput Current Range100143%lomaxCurrent Limit InceptionNon-latching110143%lomax	Maximum Input Current	35 ADC, 12 VDC Out @ 36 VDC I	n			12.3	ADC
Minimum Input Capacitance (external)         ESR < 0.7 Ω         150         μF           Inrush Transient         0.1         A <sup>2</sup> S           Input Reflected-Ripple Current, ic         25 MHz bandwidth, Io = 35 Amperes (Figure 39)         100         mA <sub>PK-PK</sub> Input Reflected-Ripple Rejection         120 Hz         45         dB           Output Obtage Ripple Rejection         120 Hz         45         dB           Output Characteristics         11.76         12.00         12.24         VDC           Output Voltage St Point (no load) <sup>1</sup> 11.76         12.00         12.24         VDC           Output Regulation <sup>1</sup> 11.76         12.00         12.24         VDC           Output Voltage Range <sup>1</sup> Vin = 39 to 75VDC [lour = 35Amps]         ±60         ±120         mV           Over Line         Vin = 39 to 75VDC [lour = 35Amps]         ±60         ±120         mV           Output Voltage Range <sup>1</sup> Over line (36 to 75VDC), load and temp. <sup>2</sup> 11.64         12.36         VDC           Output Ripple and Noise – 20 MHz bandwidth         Iour = 35Amps         100         150         mVre.rek           External Load Capacitance (Resistive load)         suffix '-xxxBx ' CExt         CExt         0         mQu           <	Input Stand-by Current	Converter disabled			10		mADC
Inrush Transient0.1A*SInput Reflected-Ripple Current, ic Input Reflected-Ripple Current, is (Figure 39)25 MHz bandwidth, lo = 35 Amperes (Figure 39)1250mARK-PKInput Voltage Ripple Rejection120 Hz45dBOutput Voltage Ripple Rejection120 Hz45dBOutput CharacteristicsOutput Voltage Set Point (no load)111.7612.0012.24VDCOutput Regulation111.7612.0012.24VDCOver LineVin = 39 to 75VDC [lour = 35Amps]±60±120mVOver Load±60±120mVVocOutput Voltage Range1Over line (39 to 75VDC), load and temp.211.6412.36VDCOutput Voltage Range1Over line (36 to 75VDC), load and temp.211.00150mVrk-PKOutput Ripple and Noise – 20 MHz bandwidth $C_{EXT} = 10 \ \mu$ F tantalum + 1 \ \muF ceramic60mVrmsSuffix '-xxxBx 'CExr020,000\muFSuffix '-xxxBx 'ESR1.000mQmQSuffix '-xxxBx 'ESR1.000mQmQSuffix '-xxxBx 'ESR1.000mQmQSuffix '-xxxBx 'ESR1.00mQmQSuffix '-xxxBx 'S377 'ESR1.7mQmQOutput Current Range35ADCADCCurrent Limit InceptionNon-latching110143%lomax	Input Current @ No Load	Converter enabled			95		mADC
Input Reflected-Ripple Current, ic Input Reflected-Ripple Current, is25 MHz bandwidth, lo = 35 Amperes (Figure 39)1250 $mA_{PK-PK}$ mA_PK-PKInput Reflected-Ripple Rejection120 Hz45dBOutput CharacteristicsOutput CharacteristicsOutput Voltage Set Point (no load) <sup>1</sup> 11.7612.0012.24VDCOutput Regulation <sup>1</sup> 11.7612.0012.24VDCOver LineVin = 39 to 75VDC [lour = 35Amps] $\pm 60$ $\pm 120$ mVOutput Voltage Range <sup>1</sup> Over line (39 to 75VDC), load and temp. <sup>2</sup> 11.6412.36VDCOutput Voltage Range <sup>1</sup> Over line (36 to 75VDC), load and temp. <sup>2</sup> 11.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidth $C_{EXT} = 10 \ \mu$ F tantalum + 1 $\mu$ F ceramic60mVrmsExternal Load Capacitance (Resistive load)suffix '-xxxBx 'ESR1.000mQsuffix '-xxxBx 'ESR1.000mQmQsuffix '-xxxBx 'ESR1.00mQmQsuffix '-xxxBx 'ESR1.00mQ </td <td>Minimum Input Capacitance (external)</td> <td><math>\text{ESR} &lt; 0.7 \ \Omega</math></td> <td>150</td> <td></td> <td></td> <td>μF</td>	Minimum Input Capacitance (external)	$\text{ESR} < 0.7 \ \Omega$	150			μF	
Input Reflected-Ripple Current, is         25 MHz bandwidth, lo = 35 Amperes (Figure 39)         100         mAex.exc           Input Voltage Ripple Rejection         120 Hz         45         dB           Output Characteristics         11.76         12.00         12.24         VDC           Output Voltage Set Point (no load) <sup>1</sup> 11.76         12.00         12.24         VDC           Output Regulation <sup>1</sup> 11.76         12.00         12.24         VDC           Over Line         Vin = 39 to 75VDC [lour = 35Amps] $\pm 60$ $\pm 120$ mV           Over Load         ±60 $\pm 120$ mV $\pm 60$ $\pm 120$ mV           Output Voltage Range <sup>1</sup> Over line (39 to 75VDC), load and temp. <sup>2</sup> 11.64         12.36         VDC           Output Regulation se - 20 MHz bandwith         Iour = 35Amps         100         150         mVreser           Cext = 10 µF tantalum + 1 µF ceramic         60         mVreser         mQ         mQ         mQ           External Load Capacitance (Resistive load)         suffix '-xxxBx '         ESR         1.000         20,000         µF           suffix '-xxxBx '         ESR         1.000         150         mQ         mQ         mQ <tr< td=""><td>Inrush Transient</td><td></td><td></td><td></td><td></td><td>0.1</td><td>A<sup>2</sup>S</td></tr<>	Inrush Transient					0.1	A <sup>2</sup> S
Input Reflected-Ripple Current, is         (Figure 39)         100         mARK-PK           Input Voltage Ripple Rejection         120 Hz         45         dB           Output Characteristics         11.76         12.00         12.24         VDC           Output Voltage Set Point (no load) <sup>1</sup> 11.76         12.00         12.24         VDC           Output Regulation <sup>1</sup> 11.76         12.00         12.24         VDC           Over Line         Vin = 39 to 75VDC [lour = 35Amps]         ±60         ±120         mV           Over Load         ±60         ±120         mV           Output Voltage Range <sup>1</sup> Over line (39 to 75VDC), load and temp. <sup>2</sup> 11.64         12.36         VDC           Output Voltage Range <sup>1</sup> Over line (36 to 75VDC), load and temp. <sup>2</sup> 11.00         150         mVrk-PK           Output Ripple and Noise - 20 MHz bandwith         Iour = 35Amps         100         150         mVrk-PK           External Load Capacitance (Resistive load)         suffix '-xxxBx '         ESR         1.000         mQ         mQ           suffix '-xxxBx S377 '         ESR         1.000         mQ         mQ         mQ           Current Limit Inception         Non-latching         110         143	Input Reflected-Ripple Current, ic	25 MHz bandwidth, Io – 35 Amp	ores		1250		mА <sub>РК-РК</sub>
Output CharacteristicsOutput Voltage Set Point (no load)1 $11.76$ $12.00$ $12.24$ VDCOutput Regulation1 $11.76$ $12.00$ $12.24$ VDCOver LineVin = 39 to 75VDC [lour = 35Amps] $\pm 60$ $\pm 120$ mVOver Load $\pm 60$ $\pm 120$ mVOutput Voltage Range1Over line (39 to 75VDC), load and temp.2 $11.64$ $12.36$ VDCOutput Voltage Range1Over line (36 to 75VDC), load and temp.2 $11.00$ $12.36$ VDCOutput Ripple and Noise - 20 MHz bandwidth $lour = 35Amps$ $100$ $150$ mVer.PecCutr = 10 µF tantalum + 1 µF ceramic $60$ mVrms $mQ$ $mQ$ External Load Capacitance (Resistive load) $suffix '-xxxBx ' ESR$ $1.000$ $m\Omega$ Suffix '-xxxBx ' ESR $1.000$ $m\Omega$ $m\Omega$ $mQ$ Output Current Range $35$ ADCCurrent Limit InceptionNon-latching $110$ $143$ %lomax	Input Reflected-Ripple Current, is				100		<b>тА</b> РК-РК
Output Voltage Set Point (no load)111.7612.0012.24VDCOutput Regulation1Vin = 39 to 75VDC [lour = 35Amps] $\pm 60$ $\pm 120$ mVOver Load $\pm 60$ $\pm 120$ mVOutput Voltage Range1Over line (39 to 75VDC), load and temp.211.6412.36VDCOutput Voltage Range1Over line (36 to 75VDC), load and temp.211.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidthIour = 35Amps100150mVrkPKCExt = 10 µF tantalum + 1 µF ceramic60mVrmsmΩsuffix '-xxxBx 'ESR1.000 $m\Omega$ mΩSuffix '-xxxBx 'ESR1.000mΩmΩOutput Current Range35ADCADCCurrent Limit InceptionNon-latching110143%lomax	Input Voltage Ripple Rejection	120 Hz			45		dB
Output Regulation¹ $\pm 60$ $\pm 120$ mVOver LineVin = 39 to 75VDC [lour = 35Amps] $\pm 60$ $\pm 120$ mVOver Load $\pm 60$ $\pm 120$ mVOutput Voltage Range¹Over line (39 to 75VDC), load and temp.²11.6412.36VDCOutput Voltage Range¹Over line (36 to 75VDC), load and temp.²11.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidth $lour = 35Amps$ 100150mVrek.ekc $C_{EXT} = 10 \ \mu$ F tantalum + 1 $\mu$ F ceramic60mVrms $Suffix '-xxxBx '< C_{EXT} 0$ 20,000 $\mu$ F $Suffix '-xxxBx '< ESR$	Output Characteristics						
Over LineVin = 39 to 75VDC [lour = 35Amps] $\pm 60$ $\pm 120$ mVOver Load $\pm 60$ $\pm 120$ mVOutput Voltage Range1Over line (39 to 75VDC), load and temp.211.6412.36VDCOutput Voltage Range1Over line (36 to 75VDC), load and temp.211.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidthlour = 35Amps100150mVrek.PKCext = 10 µF tantalum + 1 µF ceramic60mVrmsExternal Load Capacitance (Resistive load)suffix '-xxxBx 'CExt020,000µFsuffix '-xxxBx 'ESR1.000mQmQmQOutput Current Range35ADCCurrent Limit InceptionNon-latching110143%Iomax	Output Voltage Set Point (no load)1			11.76	12.00	12.24	VDC
Over Load $\pm 60$ $\pm 120$ mVOutput Voltage Range1Over line (39 to 75VDC), load and temp.211.6412.36VDCOver line (36 to 75VDC), load and temp.211.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidthlour = 35Amps100150mVrek-PK $C_{EXT} = 10 \ \mu$ F tantalum + 1 \ \ \ F ceramic60mVrms $C_{EXT} = 10 \ \mu$ F tantalum + 1 \ \ \ \ F ceramic020,000\ \ \ \ \ \ \ F mQ $suffix '-xxxBx 's'$ $ESR$ 1.000mQ $suffix '-xxxBx 's'$ $ESR$ 1.000mQ $suffix '-xxxBx 's'$ $ESR$ 1.000\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Output Regulation <sup>1</sup>						
Output Voltage Range1Over line (39 to 75VDC), load and temp.211.6412.36VDCOver line (36 to 75VDC), load and temp.211.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidth $lout = 35Amps$ 100150mVPK.PK $C_{ETT} = 10 \ \mu$ F tantalum + 1 \ \ \ F ceramic60mVrms $C_{ETT} = 10 \ \mu$ F tantalum + 1 \ \ \ \ F ceramic020,000\ \ \ \ \ \ \ \ \ mQ}suffix '-xxxBx 'C_{EXT}020,000\ \ \ \ \ \ \ \ \ mQ}suffix '-xxxBx 'C_{EXT}100100\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Over Line	Vin = 39 to 75VDC [lout = 35Amp	s]		±60	±120	mV
Output Voltage RangeOver line (36 to 75VDC), load and temp.211.0012.36VDCOutput Ripple and Noise - 20 MHz bandwidth $lour = 35Amps$ 100150mVPK-PK $C_{EXT} = 10 \ \mu$ F tantalum + 1 \ \muF ceramic60mVrms $C_{EXT} = 10 \ \mu$ F tantalum + 1 \ \muF ceramic60mVrms $mQ$ suffix '-xxxBx 'CEXT020,000 $\mu$ F $mQ$ suffix '-xxxBx 'ESR1.000mQ $mQ$ suffix '-xxxBx 'CEXT2707000 $\mu$ F $mQ$ suffix '-xxxBxS377 'CEXT2707000 $\mu$ F $mQ$ suffix '-xxxBxS377 'ESR1.7mQ $Current Limit Inception$ Non-latching110143%Iomax	Over Load				±60	±120	mV
$\begin{array}{c} \mbox{lout reprint Ripple and Noise - 20 MHz bandwidth} & \begin{tabular}{c c c c c c c } & \begin{tabular}{c c c c c c c } & \begin{tabular}{c c c c c c c c } & \begin{tabular}{c c c c c c c c } & \begin{tabular}{c c c c c c c c } & \begin{tabular}{c c c c c c c c c c c c c c c c c c c $	Output Voltage Range <sup>1</sup>	Over line (39 to 75VDC), load and	I temp. <sup>2</sup>	11.64		12.36	VDC
Output Ripple and Noise – 20 MHz bandwidth $C_{EXT} = 10 \ \mu\text{F}$ tantalum + 1 \ \mu\text{F} ceramic60 mVrmsSuffix '-xxxBx 'C_{EXT}020,000 \ \mu\text{F}suffix '-xxxBx 'ESR1.000mQsuffix '-xxxBx 'ESR1.000mQsuffix '-xxxBxS377 'C_{EXT}2707000 \ \mu\text{F}suffix '-xxxBxS377 'ESR1.7mQOutput Current Range35ADCCurrent Limit InceptionNon-latching110143			l temp. <sup>2</sup>	11.00	(		
suffix '-xxxBx '         C <sub>EXT</sub> 0         20,000         μF           suffix '-xxxBx '         ESR         1.000         mΩ           suffix '-xxxBx '         ESR         1.000         μF           suffix '-xxxBx '         ESR         1.000         μF           output Current Range         35         ADC           Current Limit Inception         Non-latching         110         143         %Iomax	Output Ripple and Noise - 20 MHz bandwidth				100		
External Load Capacitance (Resistive load)suffix '-xxxBx ' suffix '-xxxBxS377 ' suffix '-xxxBxS377 ' ESRESR1.000mΩOutput Current Range35ADCCurrent Limit InceptionNon-latching110143%Iomax				0			
Current Limit Inception Non-latching 110 143 %Iomax	External Load Capacitance (Resistive load)	suffix ' –xxxBx ' suffix ' –xxxBxS377 '	ESR C <sub>EXT</sub>	1.000 270			mΩ µF
	Output Current Range					35	ADC
Peak Short-Circuit Current <sup>3</sup> Non-latching, Short = 10 m $\Omega$ 5570A	Current Limit Inception	Non-latching		110		143	%lomax
	Peak Short-Circuit Current <sup>3</sup>	Non-latching, Short = 10 mΩ			55	70	А
RMS Short-Circuit CurrentNon-latching5Arms	RMS Short-Circuit Current	Non-latching			5		Arms



tech.support@psbel.com belfuse.com/power-solutions

Isolation Characteristics				
I/O Isolation (suffix ' -xxx0x')	1.500			VDC
Isolation Capacitance Input-to-Output		1300		ρF
Isolation Resistance	10			MΩ
I/O Isolation (suffix ' -xxxBx') Input-to-Output & Baseplate-to-Input/Output	1.500			VDC
Isolation Capacitance Input-to-Output		1300		ρF
Isolation Resistance Input-to-Output & Baseplate-to-Input/Output	10			MΩ
Feature Characteristics				
Switching Frequency		250		kHz
Output Voltage Trim Range <sup>4</sup>		n/a		%
Remote Sense Compensation <sup>4</sup>		n/a		%
Output Overvoltage Protection Non-latching	117	122	127	%
Over-Temperature Shutdown (PCB) Non-latching		130		°C
Auto-Restart Period Applies to all protection features		200		ms
Turn-On Time including Rise Time     20,000µF plus Full Load (resistive)		15	30	ms
Rise Time From 10% to 90%		13	25	ms
Turn-On Time from Vin         Time from UVLO to Vo=90%VouT(NOM)           Resistive load         Resistive load	3	5	10	ms
Turn-On Time from ON/OFF Control         Time from UVLO to Vo=90%Vout(NOM)           Resistive load         Resistive load		12		ms
Turn-On Time from Vin (w/Cext max.)     Time from UVLO to Vo=90%V <sub>OUT</sub> (NOM)       Resistive load, CEXT=10,000µF load	5	10	25	ms
Turn-On Time from ON/OFF Control (w/Cext     Time from ON to Vo=90%Vout(NOM)       max.)     Resistive load, CEXT=10,000µF load		14		ms
ON/OFF Control (Positive Logic)				
Converter Off (logic low)	-20		0.8	VDC
Converter On (logic high)	2.4		20	VDC
ON/OFF Control (Negative Logic)				
Converter Off (logic low)	2.4		20	VDC
Converter On (logic high)	-20		0.8	VDC
Dynamic Response				
Load Change 50%-75%-50%, di/dt = 0.1A/ $\mu$ s Co = 1 $\mu$ F ceramic + 10 $\mu$ F tantalum		200	360	mV
$di/dt = 1.0 A/\mu s$ Co = 1 $\mu$ F ceramic + 10 $\mu$ F tantalum		350	540	mV
Settling Time to 1% of V <sub>OUT</sub>		200		μs
Efficiency				
		95		%
100% Load Vin = 39VDC				
100% Load         Vin = 39VDC           50% Load         Vin = 39VDC		96		%
	_	96	_	%
50% Load Vin = 39VDC		96	95	%



**Asia-Pacific** +86 755 298 85888 Europe, Middle East +353 61 225 977 North America +1 408 785 5200

© 2019 Bel Power Solutions & Protection

BCD.00771\_AC

Mechanical						
Weight	No baseplate	1.75 [49.6]	oz [g]			
	With baseplate	2.15 [61.0]	0= [9]			
Vibration	GR-63-CORE, Sect. 5.4.2	1	g			
Shocks	Half Sinewave, 3-axis	50	g			
Reliability						
MTBE	Telcordia SR-332, Method I Case 1	18.8	MHrs			
	50% electrical stress, 40°C components					
EMI and Regulatory Compliance						
Conducted Emissions	CISPR 22 B with external EMI filter network (See Fig. 41)					

- <sup>1)</sup> Measured at the output pins of the converter.
- <sup>2)</sup> Operating ambient temperature range of -40 °C to 85 °C for converter.
- <sup>3)</sup> Peak currents exist for approximately 500uSec per 200msec period.
- <sup>4)</sup> This functionality not provided, however the unit is fully regulated.

#### 2. OPERATIONS

#### 2.1 INPUT AND OUTPUT IMPEDANCE

These power converters have been designed to be stable with no external capacitors when used in low inductance input and output circuits.

In many applications, the inductance associated with the distribution from the power source to the input of the converter can affect the stability of the converter. The addition of a 150  $\mu$ F electrolytic capacitor with an ESR < 0.7  $\Omega$  across the input helps to ensure stability of the converter. In many applications, the user has to use decoupling capacitance at the load. The power converter will exhibit stable operation with external load capacitance up to 20,000  $\mu$ F.

Additionally, see the EMC section of this data sheet for discussion of other external components which may be required for control of conducted emissions.

#### 2.2 ON/OFF (Pin 2)

The ON/OFF pin is used to turn the power converter on or off remotely via a system signal. There are two remote control options available, positive and negative logic, with both referenced to Vin(-). A typical connection is shown in Fig. 1.



Figure 1. Circuit configuration for ON/OFF function.

The positive logic version turns on when the ON/OFF pin is at logic high and turns off when at logic low. The converter is on when the ON/OFF pin is left open. See the Electrical Specifications for logic high/low definitions.

The negative logic version turns on when the ON/OFF pin is at logic low and turns off when the ON/OFF pin is at logic high. The ON/OFF pin can be hardwired directly to Vin(-) to enable automatic power up of the converter without the need of an external control signal.

The ON/OFF pin is internally pulled up to 5 V through a resistor. A properly debounced mechanical switch, open-collector transistor, or FET can be used to drive the input of the ON/OFF pin. The device must be capable of sinking up to 0.2mA at a low level voltage of 0.8 V. An external voltage source ( $\pm$ 20 V maximum) may be connected directly to the ON/OFF input, in which case it must be capable of sourcing or sinking up to 1mA depending on the signal polarity. See the Startup Information section for system timing waveforms associated with use of the ON/OFF pin.

The converter's output overvoltage protection (OVP) senses the voltage across Vout(+) and Vout(-), so the resistance (and resulting voltage drop) between the output pins of the converter and the load should be minimized to prevent unwanted triggering of the OVP function.



#### **3. PROTECTION FEATURES**

#### 3.1 INPUT UNDERVOLTAGE LOCKOUT

Input under-voltage lockout is standard with this converter. The converter will shut down when the input voltage drops below a pre-determined voltage.

The input voltage must be typically 34 V for the converter to turn on. Once the converter has been turned on, it will shut off when the input voltage drops typically below 33 V. This feature is beneficial in preventing deep discharging of batteries used in telecom applications.

#### 3.2 OUTPUT OVERCURRENT PROTECTION (OCP)

The converter is protected against overcurrent or short circuit conditions. Upon sensing an overcurrent condition, the converter will switch to constant current operation and thereby begin to reduce output voltage. When the output voltage drops below approx. 60% of the nominal value of output voltage, the converter will shut down.

Once the converter has shut down, it will attempt to restart nominally every 200 ms with a typical 3% duty cycle. The attempted restart will continue indefinitely until the overload or short circuit conditions are removed or the output voltage rises above 60% of its nominal value.

Once the output current is brought back into its specified range, the converter automatically exits the hiccup mode and continues normal operation.

#### 3.3 OUTPUT OVERVOLTAGE PROTECTION (OVP)

The converter will shut down if the output voltage across Vout(+) (Pin 5) and Vout(-) (Pin 4) exceeds the threshold of the OVP circuitry. The OVP circuitry contains its own reference, independent of the output voltage regulation loop. Once the converter has shut down, it will attempt to restart every 200 ms until the OVP condition I removed.

#### 3.4 OVERTEMPERATURE PROTECTION (OTP)

The converter will shut down under an over temperature condition to protect itself from overheating caused by operation outside the thermal derating curves, or operation in abnormal conditions such as system fan failure. After the converter has cooled to a safe operating temperature, it will automatically restart.

#### 3.5 SAFETY REQUIREMENTS

The converters are safety approved to UL/CSA60950-1, EN60950-1, and IEC60950-1. Basic Insulation is provided between input and output.

The converters have no internal fuse. To comply with safety agencies requirements, an input line fuse must be used external to the converter. A 20-A fuse is recommended for use with this product.

The QME48T35120 converter is CSA approved for a maximum fuse rating of 20A.

#### 3.6 ELECTROMAGNETIC COMPATIBILITY (EMC)

EMC requirements must be met at the end-product system level, as no specific standards dedicated to EMC characteristics of board mounted component dc-dc converters exist. However, Power Bel Solutions tests its converters to several system level standards, primary of which is the more stringent EN55022,

Information technology equipment - Radio disturbance characteristics-Limits and methods of measurement. An effective internal LC differential filter significantly reduces input reflected ripple current, and improves EMC. With the addition of a simple external filter, the QME48T35120 converter will pass the requirements of Class B conducted emissions per EN55022 and FCC requirements. Refer to Figures 41 and 42 for typical performance with external filter.

#### 3.7 ABSENCE OF THE REMOTE SENSE PINS

Users should note that this converter does not have a Remote Sense feature. Care should be taken to minimize voltage drop on the user's motherboard.



 Asia-Pacific
 Europe

 +86 755 298 85888
 +35

Europe, Middle East +353 61 225 977

#### 3.8 STARTUP INFORMATION (USING NEGATIVE ON/OFF)

#### Scenario #1: Initial Startup From Bulk Supply ON/OFF function enabled, converter started via application of V<sub>IN</sub>. See Figure 2.

Time	Comments
to	ON/OFF pin is ON; system front-end power is
	toggled on, V <sub>IN</sub> to converter begins to rise.

- t<sub>1</sub> V<sub>IN</sub> crosses Under-Voltage Lockout protection circuit threshold; converter enabled.
- t<sub>2</sub> Converter begins to respond to turn-on command (converter turn-on delay).
- t<sub>3</sub> Converter V<sub>OUT</sub> reaches 100% of nominal value

For this example, the total converter startup time (t\_3- t\_1) is typically 8 ms.

# Scenario #2: Initial Startup Using ON/OFF Pin With V<sub>IN</sub> previously powered, converter started via ON/OFF pin. See Figure 3. Time Comments to V<sub>INPUT</sub> at nominal value. t1 Arbitrary time when ON/OFF pin is enabled (converter started).

- t<sub>2</sub> End of converter turn-on delay.
- t<sub>3</sub> Converter V<sub>OUT</sub> reaches 100% of nominal value.

For this example, the total converter startup time (t\_{3^-} t\_1) is typically 8 ms.

#### Scenario #3: Turn-off and Restart Using ON/OFF Pin With $V_{IN}$ previously powered, converter is disabled and then enabled via ON/OFF pin. See Figure 4.

Time

#### Comments

- t₀ V<sub>IN</sub> and V<sub>OUT</sub> are at nominal values; ON/OFF pin ON.
   t₁ ON/OFF pin arbitrarily disabled; converter output falls to zero; turn-on inhibit delay period (200 ms typical) is initiated, and ON/OFF pin action is internally inhibited.
   t₂ ON/OFF pin is externally re-enabled.
  - If (t₂- t₁) ≤ 200 ms, external action of ON/OFF
    pin is locked out by startup inhibit timer.
    If (t₂- t₁) > 200 ms, ON/OFF pin action is
    internally enabled.
- t<sub>3</sub> Turn-on inhibit delay period ends. If ON/OFF pin is ON, converter begins turn-on; if off, converter awaits ON/OFF pin ON signal; see Figure 4.
- t<sub>4</sub> End of converter turn-on delay.
- t<sub>5</sub> Converter V<sub>OUT</sub> reaches 100% of nominal value.

For the condition,  $(t_2-t_1) \le 200$  ms, the total converter startup time  $(t_5-t_2)$  is typically 208 ms. For  $(t_2-t_1) > 200$  ms, startup will be typically 8 ms after release of ON/OFF pin.







#### 4. CHARACTERIZATION

#### 4.1 GENERAL INFORMATION

The converter has been characterized for many operational aspects, to include thermal derating (maximum load current as a function of ambient temperature and airflow) for vertical and horizontal mountings, efficiency, startup and shutdown parameters, output ripple and noise, transient response to load step-change, overload, and short circuit.

#### 4.2 TEST CONDITIONS

All data presented were taken with the converter soldered to a test board, specifically a 0.060" thick printed wiring board (PWB) with four layers. The top and bottom layers were not metalized. The two inner layers, comprised of two-ounce copper, were used to provide traces for connectivity to the converter.

The lack of metallization on the outer layers as well as the limited thermal connection ensured that heat transfer from the converter to the PWB was minimized. This provides a worst-case but consistent scenario for thermal derating purposes. All measurements requiring airflow were made in the vertical and horizontal wind tunnel using Infrared (IR) thermography and thermocouples for thermometry.

Ensuring components on the converter do not exceed their ratings is important to maintaining high reliability. If one anticipates operating the converter at or close to the maximum loads specified in the derating curves, it is prudent to check actual operating temperatures in the application. Thermographic imaging is preferable; if this capability is not available, then thermocouples may be used. The use of AWG #36 gauge thermocouples is recommended to ensure measurement accuracy. Careful routing of the thermocouple leads will further minimize measurement error. Refer to Fig. 5 for the optimum measuring thermocouple location.

#### 4.3 THERMAL DERATING

Thermal characterization is provided for the hotspot temperatures of both 120°C and 125°C. Load current vs. ambient temperature and airflow rates are shown in Fig. 6, Fig. 8, Fig. 10 and Fig. 12. Ambient temperature was varied between 25°C and 85°C, with airflow rates from 30 to 500 LFM (0.15 to 2.5 m/s). For each set of conditions, the maximum load current was defined as the lowest of:

Case I : T<sub>C</sub> (Hotspot) ≤ 120°C

- (i) The output current at which any FET junction (T<sub>.</sub>) temperature does not exceed a maximum temperature of 120°C as indicated by the thermal measurement, or
- (ii) The output current at which the temperature at the thermocouple locations TC do not exceed 120°C. (Fig. 5)
- (iii) The nominal rating of the converter (35 A).

Case II : T<sub>C</sub> (Hotspot) ≤ 125°C

- (i) The output current at which any FET junction (TJ) temperature does not exceed a maximum temperature of 125°C as indicated by the thermal measurement, or
- (ii) The output current at which the temperature at the thermocouple locations TC do not exceed 125°C. (Fig. 5)
- (iii) The nominal rating of the converter (35 A).



Figure 5. Location of the thermocouples for thermal testing



**Asia-Pacific** +86 755 298 85888 Europe, Middle East +353 61 225 977 North America +1 408 785 5200

#### 4.4 OUTPUT POWER

The output power vs. ambient temperature and airflow rates are given in Fig. 7 and Fig. 9 w/o baseplate. The output power vs. ambient temperature and airflow rates are given in Fig. 11 and Fig. 13 with baseplate. The ambient temperature varies between 25°C and 85°C with airflow rates from 30 to 500 LFM (0.15 to 2.5 m/s).

#### 4.5 THERMAL DERATING – BASEPLATE COOLED

The maximum load current rating vs. baseplate temperature is provided for Baseplate Models with commercially available heatsinks attached. The various configurations, T<sub>C-MAX</sub>(Hotspot) and Figure references, are listed below.

Note: T<sub>C</sub> Hotspot ≈ T<sub>J</sub> MOSFET

For a 1/4" heatsink, AAvid Thermalloy PNU 241402B92200G,  $T_c \le 120^{\circ}C$ , current derating is provided in Figure 14. Power Derating is provided in Figure 15.

For a 1/4" heatsink, AAvid Thermalloy PNU 241402B92200G,  $T_c \le 125^{\circ}C$ , current derating is provided in Figure 16. Power Derating is provided in Figure 17.

For a  $\frac{1}{2}$ " heatsink, AAvid Thermalloy PNU 241404B92200G,  $T_C \le 120^{\circ}$ C, current derating is provided in Figure 18.

For a  $\frac{1}{2}$ " heatsink, AAvid Thermalloy PNU 241404B92200G,  $T_C \le 125^{\circ}C$ , current derating is provided in Figure 20. Power Derating is provided in Figure 21.

For a 1" heatsink, AAvid Thermalloy PNU 241409B92200G,  $T_C \le 120^{\circ}C$ , current derating is provided in Figure 22. Power Derating is provided in Figure 23.

For a 1" heatsink, AAvid Thermalloy PNU 241409B92200G,  $T_C \le 125^{\circ}C$ , current derating is provided in Figure 24. Power Derating is provided in Figure 25.

#### 4.6 THERMAL DERATING - COLDPLATE COOLED

The converter was shielded from air flow. The baseplate temperature was maintained  $\leq 85^{\circ}$ C, with an airflow rate of  $\geq 30$ LFM ( $\geq 0.15$ m/s). Thermocouple measurements (in Fig. 5) were recorded as T<sub>C</sub>  $\leq 120^{\circ}$ C and T<sub>B</sub>  $\leq 85^{\circ}$ C. Refer to Figure 26 and Figure 27.

#### 4.7 EFFICIENCY

Efficiency vs. load current is showing in Fig. 28 for ambient temperature ( $T_A$ ) of 25°C, airflow rate of 300LFM (1.5m/s) with vertical mounting and input voltages of 36V, 48V, and 75V. Also, a plot of efficiency vs. load current, as a function of ambient temperature with Vin = 48V, airflow rate of 200 LFM (1 m/s) with vertical mounting is shown in Fig. 29.

#### 4.8 **POWER DISSIPATION**

Power dissipation vs. load current is showing in Fig. 30 for TA =  $25^{\circ}$ C, airflow rate of 300LFM (1.5m/s) with vertical mounting and input voltages of 36V, 48V, and 75V. Also, a plot of power dissipation vs. load current, as a function of ambient temperature with Vin = 48V, airflow rate of 200 LFM (1m/s) with vertical mounting is shown in Fig. 31.

#### 4.9 START UP

Output voltage waveforms, during the turn-on transient using the ON/OFF pin for full rated load currents (resistive load) are shown without and with external load capacitance in Fig. 30 and Fig. 33, respectively.

#### 4.10 RIPPLE AND NOISE

Fig. 36 show the output voltage ripple waveform, measured at full rated load current with a 10  $\mu$ F tantalum and 1  $\mu$ F ceramic capacitor across the output. Note that all output voltage waveforms are measured across a 1  $\mu$ F ceramic capacitor. The input reflected ripple current waveforms are obtained using the test setup shown in Fig. 37. The corresponding waveforms are shown in Fig. 38 and Fig. 39.





Figure 6. Available output current vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 120 °C., Vin = 48 V.

#### 450 400 350 [W] 300 Output Power 250 200 500LFM (2.5 m/s) 400LFM (2.0 m/s) . 300LFM (1.5 m/s) 200LFM (1.0 m/s) 150 100 100LFM (0.5 m/s) 30LFM (0.15 m/s) 50 0 20 30 40 50 60 70 80 90 Ambient Temperature [°C]

Figure 7. Available output power vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 120 °C., Vin = 48 V.



Figure 8. Available output current vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 120 °C., Vin = 48 V.

#### 450 400 350 350 300 400 500 LFM (2.5 m/s) 150 150 150 LFM (0.15 m/s) 30 LFM (0.15 m/s) 500 LFM

0 \_\_\_\_20 30 40 50 60 70 80 90

#### Ambient Temperature [°C]

Figure 9. Available output power vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 120 °C, Vin = 48 V.



**Asia-Pacific** +86 755 298 85888 Europe, Middle East +353 61 225 977 North America +1 408 785 5200

© 2019 Bel Power Solutions & Protection

#### Figures 8 & 9 with Baseplate, TC ≤ 120 °C.

#### Figures 10 & 11 without Baseplate, $T_C \le 125 \ ^{\circ}C$ .



Figure 10. Available output current vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 125 °C, Vin = 48 V.



Figure 11. Available output power vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 125 °C, Vin = 48 V.



Figure 12. Available output current vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 125 °C, Vin = 48 V.

450 400 350 N 300 Power 250 Output 200 500 LEM (2.5 m/s) 400 LFM (2.0 m/s) 150 300 LFM (1.5 m/s) 200 LFM (1.0 m/s) 100 100 LFM (0.5 m/s) 30 LFM (0.15 m/s) 50 0 \_\_\_\_ 20 30 40 50 60 70 80 90

#### Ambient Temperature [°C]

Figure 13. Available output power vs. ambient air temperature and airflow rates for converter with baseplate vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 125 °C , Vin = 48 V.



#### Figures 12 & 13 with Baseplate, TC ≤ 125 °C.



#### Ambient Temperature [°C]

Figure 14. Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature  $\leq$  120 °C , Vin = 48 V, ¼" Heatsink.



11

#### Ambient Temperature [°C]

Figure 15. Available output power vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature  $\leq 120 \ ^{\circ}C$ , Vin = 48 V, 1/4" Heatsink.



## Ambient Temperature [°C]





#### Ambient Temperature [°C]





Asia-Pacific +86 755 298 85888 Europe, Middle East +353 61 225 977

**North America** +1 408 785 5200

© 2019 Bel Power Solutions & Protection

M) Output Power

Figures 16 & 17 with ¼" Finned Heatsink, TC ≤ 125 °C.

Figures 14 & 15 with  $\frac{1}{4}$ " Finned Heatsink.  $T_c \leq 120 \ ^{\circ}C$ .

#### Figures 18 & 19 with $\frac{1}{2}$ " Finned Heatsink, $T_C \le 120$ °C.



#### Ambient Temperature [°C]

Figure 18. Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature ≤ 120 °C, Vin = 48 V, ½" Heatsink.



#### Ambient Temperature [°C]





#### Ambient Temperature [°C]





#### Ambient Temperature [°C]





450

400

350

## 460 400 350 500 LFM (2.5 m/s) 400 LFM (2.5 m/s) 150



#### Ambient Temperature [°C]





#### Ambient Temperature [°C]

Figure 23. Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature  $\leq 120 \ ^{\circ}C$ , Vin = 48 V, 1" Heatsink.



#### Ambient Temperature [°C]

Figure 24. Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature  $\leq 125 \text{ °C}$ , Vin = 48 V, 1" Heatsink.



#### Ambient Temperature [°C]





**Asia-Pacific** +86 755 298 85888 Europe, Middle East +353 61 225 977 North America +1 408 785 5200

© 2019 Bel Power Solutions & Protection

#### Figures 24 & 25 with 1" Finned Heatsink, $T_C \le 125$ °C.

Figures 22 & 23 with 1" Finned Heatsink,  $T_C \leq 120$  °C.

Figures 26 & 27 Coldplate Cooling  $T_C \le 120$  °C.



Figure 26. Current derating of QME48T35120 converter with baseplate option and coldplate cooling. (Conditions: Air velocity ≥ 30LFM (≥ 0.15m/s), Vin = 48 V, T<sub>B</sub> ≤ 85°C, T<sub>C</sub> ≤ 120°C. No thermal derating required.







Figure 28. Efficiency vs. load current and input voltage for converter w/o baseplate mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5 m/s) and Ta=25°C.



Figure 29. Efficiency vs. load current and ambient temperature for converter w/o baseplate mounted vertically with Vin=48V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0m/s).





Figure 30. Power dissipation vs. load current and input voltage for converter w/o baseplate mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5 m/s) and Ta = 25 °C.



Figure 32. Turn-on transient at full rated load current (resistive) with no output capacitor at Vin = 48 V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5 V/div.). Bottom trace: output voltage (5 V/div.). Time scale: 5 ms/div.



Figure 34. Output voltage response to load current stepchange (17.5 A – 26.25 A – 17.5 A) at Vin = 48 V. Top trace: output voltage (100 mV/div.). Bottom trace: load current (10 A/div.). Current slew rate: 0.1 A/μs. Co = 1 μF ceramic + 10 μF tantalum. Time scale: 200 μs/div.



Figure 31. Power dissipation vs. load current and ambient temperature for converter w/o baseplate mounted vertically with Vin = 48 V and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0 m/s).



Figure 33. Turn-on transient at full rated load current (resistive) plus 20,000 μF at Vin = 48 V, triggered via ON/OFF pin. Top trace: ON/OFF signal (5 V/div.). Bottom trace: output voltage (5 V/div.). Time scale: 5 ms/div



Figure 35. Output voltage response to load current stepchange (17.5 A – 26.25 A – 17.5 A) at Vin = 48 V. Top trace: output voltage (200 mV/div.). Bottom trace: load current (10 A/div.). Current slew rate: 1 A/μs. Co = 1 μF ceramic + 10 μF tantalum. Time scale: 200 μs/div.



**Asia-Pacific** +86 755 298 85888 Europe, Middle East +353 61 225 977 North America +1 408 785 5200



Figure 36. Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with Co = 10 μF tantalum + 1 μF ceramic and Vin = 48 V. Time scale: 2 μs/div.



Figure 38. Input reflected ripple current, ic (500 mA/div.), measured at input terminals at full rated load current and Vin = 48 V. Refer to Fig. 37 for test setup. Time scale: 2 μs/div.



Figure 40. Load current (top trace, 20 A/div., 100 ms/div) into a 10 m $\Omega$  short circuit during restart, at Vin = 48 V. Bottom trace (20 A/div., 100 ms/div.) is an expansion of the on-time portion of the top trace.





Figure 37. Test setup for measuring input reflected ripple currents, ic and is.



Figure 39. Input reflected ripple current, is (50 mA/div.), measured through 5  $\mu$ H at the source at full rated load current and Vin = 48 V. Refer to Fig. 37 for test setup. Time scale: 2  $\mu$ s/div.





COMPONENT DESCRIPTION	DESCRIPTION
C1, C2, C3	2 x 1uF, 100 V Ceramic Capacitor
C4, C5, C7, C8	4700pF Ceramic Capacitor
C6	100uF, 100 V Electrolytic Capacitor
L1, L2	0.59mH, P0469NL Pulse Eng. Or, equiv



Figure 42. Input conducted emissions measurement (Typ.) of QME48T35120 with input filter shown in Figure 41. Conditions:  $V_{IN}$ =48VDC,  $I_{OUT}$  = 35AMPS



**Asia-Pacific** +86 755 298 85888 Europe, Middle East +353 61 225 977 North America +1 408 785 5200

## 5. MECHANICAL PARAMETERS

#### QME48T35120 Pinout (Trough-hole)



PAD/PIN CONNECTIONS							
Pad/Pin #	Function						
1	Vin (+)						
2	ON/OFF						
3	Vin (-)						
4	Vout (-)						
5	Vout (+)						

• All dimensions are in inches [mm]

- Pins 1 3 are Ø 0.040" [1.02] with Ø 0.076" [1.93] shoulder
- Pins 4 and 5 are Ø 0.062" [1.57] with Ø 0.096" [2.44] shoulder
- Pin Material: Brass Alloy 360
- Pin Finish: Tin over Nickel
- Heatsink Mounting Screw: 3 in Ib
   maximum torque

	Height [HT]	Minimum Clearance [CL]	Special Features	Pin Option	<b>Pin Length [PL]</b> ±0.005 [±0.13]
	0.430" [10.4] Max	0.028" [0.71]	0	А	0.188 [4.78]
J	0.500" +/- 0.020 [12.70 +/- 0.51]	0.028" [0.71]	В	В	0.145 [3.68]
				С	0.110 [2.79]

#### **Baseplate (Heat Spreader) Interface**





#### 6. ORDERING INFORMATION

Product Series	Input Voltage	Mounting Scheme	Rated Load Current	Output Voltage		ON/OFF Logic	Maximum Height [HT]	Pin Length [PL]	Special Features	RoHS	Suffix
QME	48	т	35	120	-	Ν	J	В	0	G	S 377
Quarter- Brick Format	36-75 V	Trough hole	35 A	120 ⇒ 12 V		$N \Rightarrow$ Negative $P \Rightarrow$ Positive	$J \Rightarrow 0.430"$ for - xJx0x J $\Rightarrow 0.520"$ for - xJxBx	$\begin{array}{l} A \Rightarrow 0.188"\\ B \Rightarrow 0.145"\\ C \Rightarrow 0.110" \end{array}$	$0 \Rightarrow STD$ B $\Rightarrow$ Baseplate option	No Suffix ⇒ RoHS lead-solder- exemption compliant G ⇒ RoHS compliant for all six substances	S 377 ⇒ Specially made to suit the dynamic load application

The example above describes P/N QME48T35120-NJB0G: 36-75 V input, through-hole mounting, 35 A @ 12 V output, negative ON/OFF logic, a maximum height of 0.430", 0.145" pin length, and standard (no baseplate), RoHS compliant for all 6 substances. Consult factory for availability of other options.

#### 7. REVISION HISTORY

DATE	REVISION	DESCRIPTION OF CHANGE	ECO/MCO REFERENCE NO.
2019-Jul-26	AC	Page 19: Suffix S377 added to Ordering Information Table referring to added capability of 10000 $\mu$ F start up.	C95653

#### For more information on these products consult: tech.support@psbel.com

NUCLEAR AND MEDICAL APPLICATIONS - Products are not designed or intended for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems. TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on

**TECHNICAL REVISIONS** - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.



Asia-Pacific +86 755 298 85888 Europe, Middle East +353 61 225 977

© 2019 Bel Power Solutions & Protection

BCD.00771\_AC